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#### November 2014

## **FCPF400N80ZL1** N-Channel SuperFET<sup>®</sup> II MOSFET 800 V, 11 A, 400 mΩ

#### Features

- Typ. R<sub>DS(on)</sub> = 340 mΩ
- Ultra Low Gate Charge (Typ. Q<sub>q</sub> = 43 nC)
- Low E<sub>oss</sub> (Typ. 4.1 uJ @ 400 V)
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 138 pF)
- 100% Avalanche Tested
- RoHS Compliant
- ESD Improved Capability

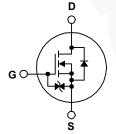
### Applications

- AC-DC Power Supply
- LED Lighting

### Description

SuperFET<sup>®</sup> II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. In addition, internal gate-source ESD diode allows to withstand over 2kV HBM surge stress. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.





#### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

| Symbol                            | Parameter   Drain to Source Voltage                                     |  |           | FCPF400N80ZL1 | Unit<br>V |  |
|-----------------------------------|---|--|-----------|---------------|-----------|--|
| V <sub>DSS</sub>                  |   |  |           | 800           |           |  |
| V <sub>GSS</sub>                  | Gate to Source Voltage  | - DC   |           | ±20           | V         |  |
|                                   |   | - AC   | (f >1 Hz) | ±30           | V         |  |
| ID                                | Drain Current   | - Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)  |           | 11*           | Α         |  |
|                                   |   | - Continuous (T <sub>C</sub> = 100 <sup>o</sup> C) |           | 6.9*          |           |  |
| I <sub>DM</sub>                   | Drain Current   | - Pulsed   | (Note 1)  | 33*           | Α         |  |
| E <sub>AS</sub>                   | Single Pulsed Avalanche Energy (Note 2                                  |  |           | 339           | mJ        |  |
| I <sub>AR</sub>                   | Avalanche Current   | (Note 1)   | 2.2       | Α             |           |  |
| E <sub>AR</sub>                   | Repetitive Avalanche Energy   |  | (Note 1)  | 0.36          | mJ        |  |
| dv/dt                             | MOSFET dv/dt  |  |           | 100           | V/ns      |  |
|                                   | Peak Diode Recovery dv/dt   |  |           | 20            |           |  |
| P <sub>D</sub>                    | Dower Discinction   | (T <sub>C</sub> = 25 <sup>o</sup> C)               |           | 35.7          | W         |  |
|                                   | Power Dissipation   | - Derate Above 25°C                                |           | 0.29          | W/ºC      |  |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Temperature Range                                 |  |           | -55 to +150   | °C        |  |
| TL                                | Maximum Lead Temperature for Soldering,<br>1/8" from Case for 5 Seconds |  |           | 300           | °C        |  |

\*Drain current limited by maximum junction temperature.

#### Thermal Characteristics

| Symbol              | Parameter                                     | FCPF400N80ZL1 | Unit |  |
|---------------------|---|---------------|------|--|
| $R_{	ext{	heta}JC}$ | Thermal Resistance, Junction to Case, Max.    | 3.5           | °C/W |  |
| $R_{\thetaJA}$      | Thermal Resistance, Junction to Ambient, Max. | 62.5          | 0/11 |  |

| Part Nu                                       | mber   | Top Mark                          | Package      | Packing Method  | Reel Siz                          | e    | Tape Width | ı Qu     | antity |  |
|---|--|-----------------------------------|--------------|---|-----------------------------------|------|------------|----------|--------|--|
| FCPF400                                       |  |                                   | TO-220F      | Tube  | N/A                               |      | N/A        | 50 units |        |  |
| Electrica                                     | al Char  | acteristics T <sub>C</sub> = 25°  | C unless oth | nerwise noted.  |                                   |      |            |          |        |  |
| Symbol  |  | Parameter                         |              | Test Conditions   | s                                 | Min. | Тур.       | Max.     | Unit   |  |
| Off Chara                                     | cteristic  | S                                 |              |   |                                   |      |            |          |        |  |
| BV <sub>DSS</sub>                             | Drain to   | Drain to Source Breakdown Voltage |              | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA, T <sub>J</sub> = 25°C                         |                                   |      | -          | -        | V      |  |
| $\Delta BV_{DSS}$                             |  | Breakdown Voltage Temperature     |              |   |                                   | 800  | 0.0        |          |        |  |
| $/\Delta T_{J}$                               | Coefficient  |                                   | ID           | $I_D = 1 \text{ mA}$ , Referenced to $25^{\circ}$ C   |                                   |      | 0.8        | -        | V/º(   |  |
| I <sub>DSS</sub>                              | Zero Ga  | Zero Gate Voltage Drain Current   |              | <sub>S</sub> = 800 V, V <sub>GS</sub> = 0 V   |                                   |      |            | 25       | μA     |  |
| 'DSS  | 2010 00  |                                   |              | $V_{DS} = 640 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$                               |                                   | -    | -          | 250      | μΛ     |  |
| I <sub>GSS</sub>                              | Gate to Body Leakage Current                             |                                   | VG           | V <sub>GS</sub> = ±20 V, V <sub>DS</sub> = 0 V  |                                   | -    | -          | ±10      | μA     |  |
| On Chara                                      | cteristic  | s                                 |              |   |                                   |      |            |          |        |  |
|   | /  |                                   |              | $_{SS} = V_{DS}, I_{D} = 1.1 \text{ mA}$  |                                   | 2.5  | -          | 4.5      | V      |  |
| V <sub>GS(th)</sub>                           | Gate Threshold Voltage                                   |                                   |              | $_{SS} = V_{DS}, I_{D} = 0.68 \text{ mA}$   |                                   | 2.5  | -          | 4.5      |        |  |
|   |  |                                   |              | $_{SS} = 10 \text{ V}, \text{ I}_{D} = 5.5 \text{ A}$                                       |                                   |      | 0.34       | 0.4      | +      |  |
| R <sub>DS(on)</sub>                           | Static Drain to Source On Resistance                     |                                   |              | $_{SS} = 10 \text{ V}, \text{ I}_{D} = 7.1 \text{ A}$                                       |                                   | -    | 0.35       | 0.4      | Ω      |  |
| D0(011)                                       |  |                                   |              | <sub>SS</sub> = 10 V, I <sub>D</sub> = 7.1 A, T   | <sub>C</sub> = 150 <sup>o</sup> C | -    | 0.89       | -        | 1      |  |
| 9 <sub>FS</sub>                               | Forward  | d Transconductance                |              | <sub>DS</sub> = 20 V, I <sub>D</sub> = 5.5 A  | 0                                 | -    | 12         | -        | S      |  |
| Dynamic (                                     | Charact  | aristics                          |              |   | ¥                                 |      |            |          |        |  |
| C <sub>iss</sub>                              | 1  | apacitance                        |              |   |                                   |      | 1770       | 2350     | pF     |  |
| C <sub>oss</sub>                              |  | Capacitance                       | V            | V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V,<br>f = 1 MHz                                |                                   | _    | 51         | 70       | pF     |  |
| C <sub>rss</sub>                              |  | e Transfer Capacitance            | f =          |   |                                   | -    | 0.5        | -        | pF     |  |
| C <sub>oss</sub>                              |  | Capacitance                       | Ve           | V <sub>DS</sub> = 480 V, V <sub>GS</sub> = 0 V, f = 1 MHz                                   |                                   | -    | 28         | -        | pF     |  |
|   | -  | e Output Capacitance              |              | $V_{\rm DS} = 400$ V, $V_{\rm GS} = 0$ V, $1 = 100$ M/2                                     |                                   | -    | 138        | -        | pF     |  |
| C <sub>oss(eff.)</sub><br>Q <sub>g(tot)</sub> |  | ate Charge at 10V                 |              |   |                                   | -    | 43         | 56       | nC     |  |
| $Q_{gs}$                                      |  | Source Gate Charge                |              | $V_{DS} = 640 \text{ V}, \text{ I}_{D} = 11 \text{ A},$<br>$V_{GS} = 10 \text{ V}$ (Note 4) |                                   | -    | 8.6        | -        | nC     |  |
| Q <sub>gd</sub>                               |  | Drain "Miller" Charge             | • (          |   |                                   | -    | 17         | -        | nC     |  |
| ESR   |  | ent Series Resistance             | f =          | 1 MHz   | , ,                               | -    | 2.3        | -        | Ω      |  |
|   |  |                                   |              |   |                                   | -    |            |          |        |  |
| Switching                                     | Charac   | teristics                         |              |   |                                   |      |            |          |        |  |
| t <sub>d(on)</sub>                            | Turn-On  | Delay Time                        |              | $V_{DD}$ = 400 V, I <sub>D</sub> = 11 A,<br>V <sub>GS</sub> = 10 V, R <sub>g</sub> = 4.7 Ω  |                                   | -    | 20         | 50       | ns     |  |
| t <sub>r</sub>                                | Turn-On  | Rise Time                         | VD           |   |                                   |      | 12         | 34       | ns     |  |
| t <sub>d(off)</sub>                           | Turn-Off   | Delay Time                        | VG           |   |                                   | -    | 51         | 112      | ns     |  |
| t <sub>f</sub>                                | Turn-Off Fall Time                                       |                                   |              | (Note 4)  |                                   | -    | 2.6        | 15       | ns     |  |
| Drain-Sou                                     | rce Dio  | de Characteristics                |              |   |                                   |      |            |          |        |  |
| I <sub>S</sub>                                | Maximum Continuous Drain to Source Diode Forward Current |                                   |              | -   | -                                 | 11   | А          |          |        |  |
| I <sub>SM</sub>                               | Maximum Pulsed Drain to Source Diode F                   |                                   |              |   |                                   | -    | -          | 33       | A      |  |
| V <sub>SD</sub>                               |  | Source Diode Forward Vol          |              |   | -                                 | -    | 1.2        | V        |        |  |
| t <sub>rr</sub>                               |  | Recovery Time                     | -            | $V_{GS} = 0 V, I_{SD} = 11 A,$  |                                   | -    | 395        | -        | ns     |  |
| Q <sub>rr</sub>                               |  | Recovery Charge                   |              | $dl_F/dt = 100 A/\mu s$   |                                   |      | 7.4        | -        | μC     |  |

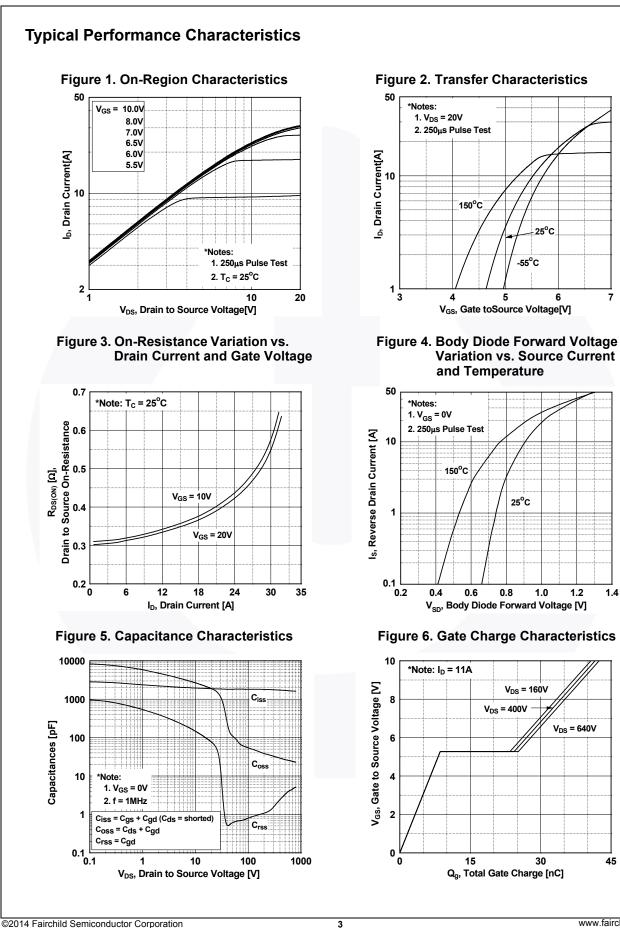
1. Repetitive rating: pulse-width limited by maximum junction temperature.

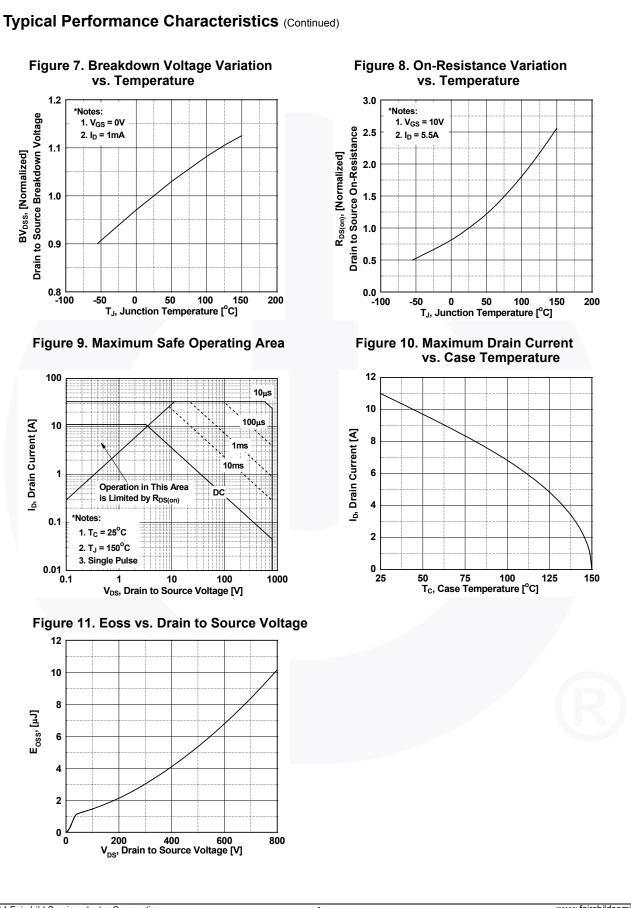
2. I\_{AS} = 2.2 A, V\_{DD} = 50 V, R\_G = 25  $\Omega,$  starting T\_J = 25°C.

3. I\_{SD}  $\leq$  11 A, di/dt  $\leq$  200 A/µs, V\_{DD}  $\leq$  BV\_{DSS}, starting T\_J = 25°C.

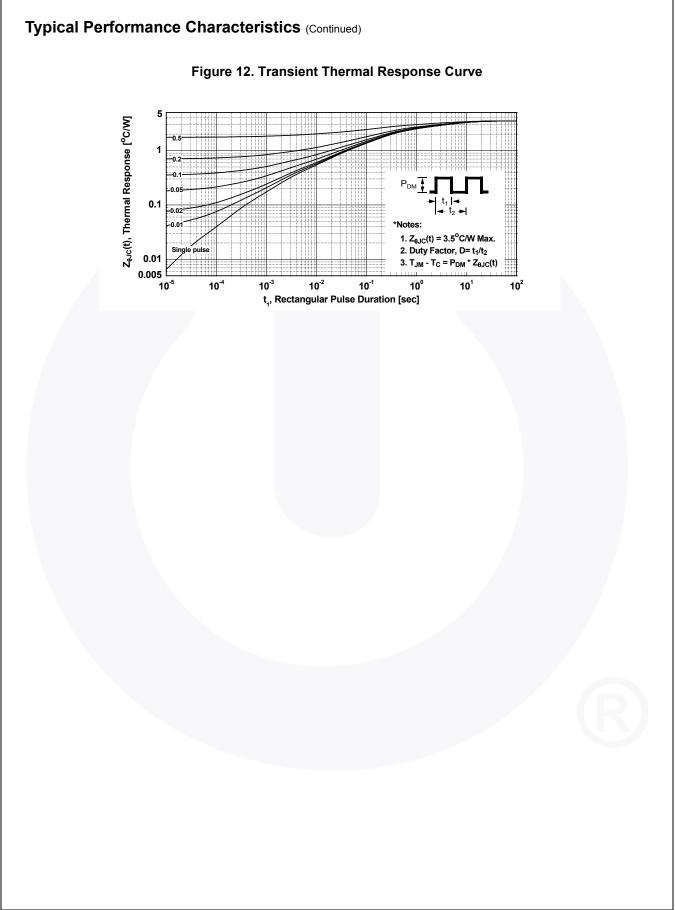
4. Essentially independent of operating temperature typical characteristics.

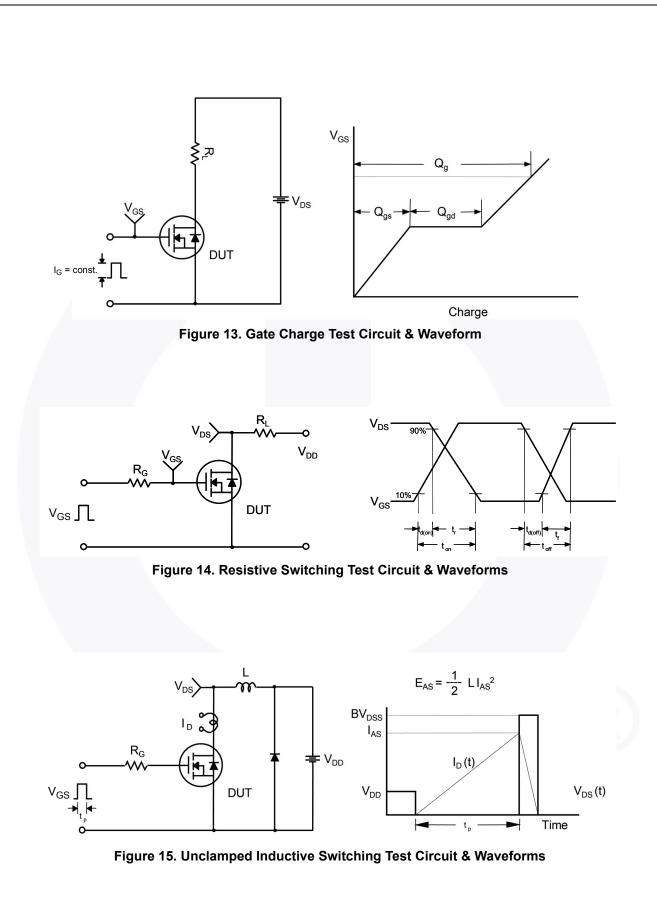
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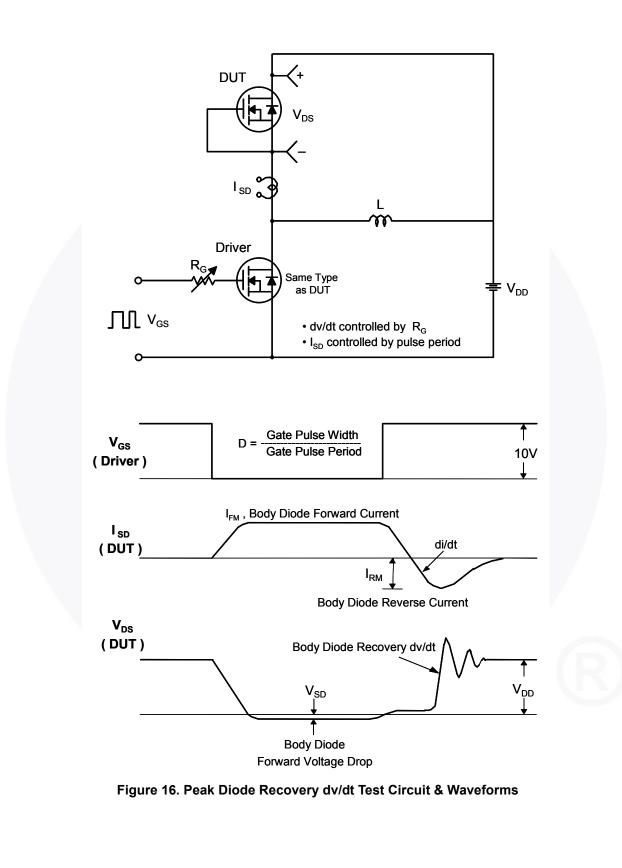
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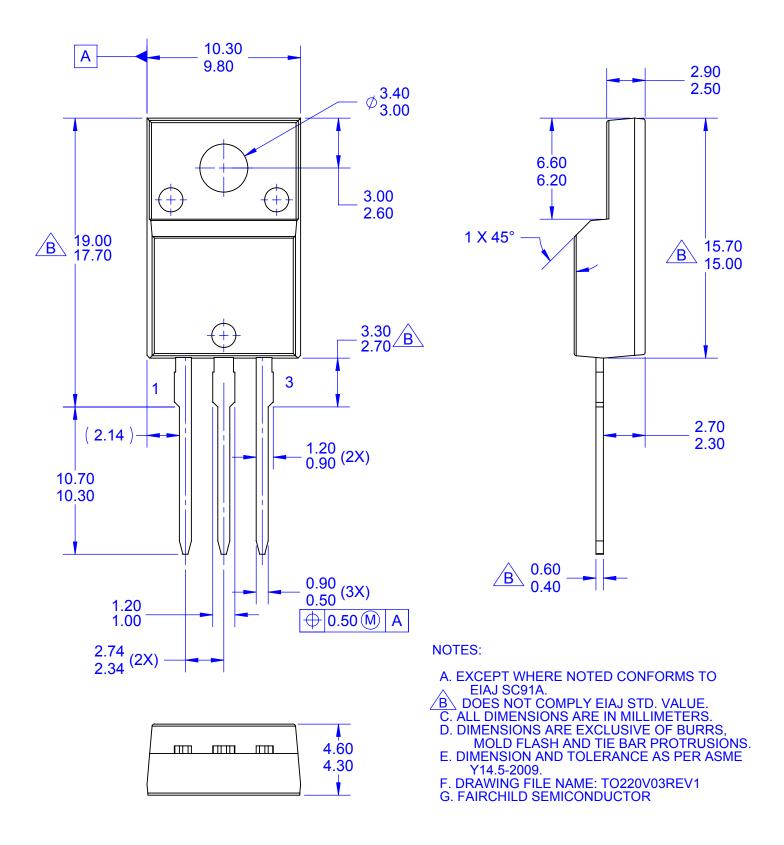




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